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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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HAT2085R

Silicon N Channel MOS FET High Speed Power Switching

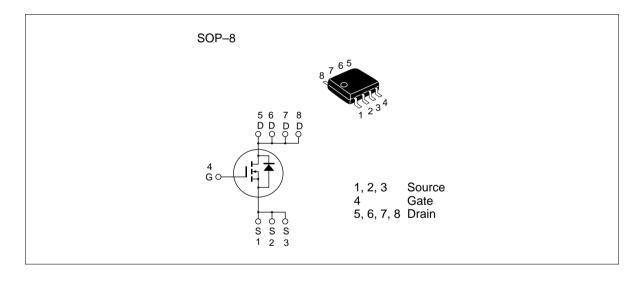


ADE-208-1232 (Z) Target Specification 1st. Edition Dec. 2000

Features

- Low on-resistance
- Low drive current
- High density mounting

Outline



HAT2085R

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit	
Drain to source voltage	V _{DSS}	200	V	
Gate to source voltage	V_{GSS}	±30	V	
Drain current	I _D	(2)	А	
Drain peak current	Note1 D(pulse)	(16)	А	
Body-drain diode reverse drain current	I _{DR}	(2)	Α	
Channel dissipation	Pch Note2	2.5	W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

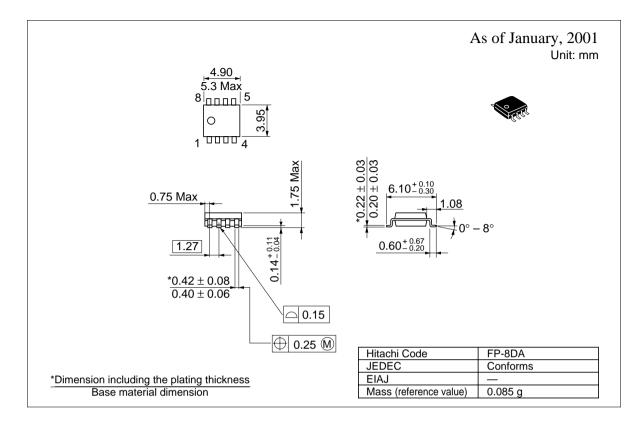
- Note: 1. PW \leq 10 μ s, duty cycle \leq 1 %
 - 2. When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW \leq 10s

Electrical Characteristics ($Ta = 25^{\circ}C$)

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	200	_	_	V	$I_{D} = 10 \text{mA}, V_{GS} = 0$
Gate to source leak current	I _{GSS}	_	_	±0.1	μΑ	$V_{GS} = \pm 30V$, $V_{DS} = 0$
Zero gate voltege drain current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 200 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{\rm GS(off)}$	(3.0)	_	(4.5)	V	$I_D = 1 \text{mA}, V_{DS} = 10 \text{V}$
Static drain to source on state resistance	$R_{\scriptscriptstyle DS(on)}$	_	(0.49)	(0.64)	Ω	$I_D = 1A$, $V_{GS} = 10V^{Note3}$
Forward transfer admittance	y _{fs}	(1.2)	(2.0)	_	S	$I_D = 1A$, $V_{DS} = 10V^{Note3}$
Input capacitance	Ciss	_	(300)	_	pF	V _{DS} = 25V
Output capacitance	Coss	_	(43)	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	(12)	_	pF	f = 1MHz
Turn-on delay time	$t_{\text{d(on)}}$	_	(20)	_	ns	$V_{DD}\cong 100V,\ I_D=1A$
Rise time	t,	_	(10)	_	ns	$V_{GS} = 10V$
Turn-off delay time	$t_{\text{d(off)}}$	_	(50)	_	ns	$R_L = 100\Omega$
Fall time	t _f	_	(10)	_	ns	$R_g = 10\Omega$
Total gate charge	Qg	_	(10)	_	nC	V _{DD} = 160V
Gate to source charge	Qgs	_	(2)	_	nC	V _{GS} = 10V
Gate to drain charge	Qgd	_	(5)	_	nC	$I_D = 2A$
Body-drain diode forward voltage	V_{DF}	_	(8.0)	(1.2)	V	$I_F = 2A, V_{GS} = 0^{Note3}$
Body-drain diode reverse recovery time	t _{rr}	_	(75)	_	ns	$I_F = 2A, V_{GS} = 0$ diF/ dt =100A/ μ s

Note: 3. Pulse test

Package Dimensions



HAT2085R

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